	line 5, change "Technical Field" to -BACKGROUND OF THE
92	INVENTION-;
(43	between lines 5 and 6, insert 1. Field of the Invention -; and
	line 8, change "Background Art" to -2. Description of Related Art
44	Page 2, before line 3, insert SUMMARY OF THE INVENTION -; and
45	line 6, delete "Disclosure of the Invention".
	Page 4, line 20, change "Brief Description of the Drawings" toBRIEF
ab	DESCRIPTION OF THE DRAWINGS
	Pages 7-8, delete the pages in their entirety.
	Page 9, delete lines 1-14 in their entirety; and
	line 16, change "Best Mode for Carrying Out the Invention" to
III.	DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS
- 471/	IN THE CLAIMS:
	Please amend claims 1-20 as follows:
	1. (Amended) A three-dimensional device comprising:
	a plurality of thin film device layers deposited in a thickness direction, each thin
	film device layer being disposed in a predetermined region in a planar direction, [wherein] at
600	least one of the thin film device ayers [is] being deposited by a transfer method.
Y)	2. (Amended) A three-dimensional device comprising:
	a plurality of thin film device layers deposited on a base in a thickness direction
	for constituting a three-dimensional circuit, each thin film device layer constituting a circuit
-	disposed in a predetermined region extending in a planar direction, [wherein] at least one of
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the thin film device layers [is] being deposited by a transfer method.